

AMENDMENTS TO THE CLAIMS:

The following listing of claims replaces all prior listings, and all prior versions, of claims in the application.

LISTING OF CLAIMS:

1. (Currently amended) A photosensitive element for a field emission display panel having (B) a filling layer having a thickness of 10 to 200 µm on a support film, and (A) a photosensitive resin composition component layer containing a phosphor and having a thickness of 5 to 200 µm on (B) the filling layer.

2. (Original) A photosensitive element for a field emission display panel according to Claim 1, wherein (A) said photosensitive resin composition layer containing a phosphor contains:
 - (a) a polymer having a film-forming property,
 - (b) a photopolymerizable unsaturated compound having an ethylenically unsaturated group,
 - (c) a photoinitiator forming a free radical by irradiation of active light, and
 - (d) a phosphor.

3. (New) A photosensitive element for a field emission display panel according to claim 1, wherein the thickness of the photosensitive resin composition layer is 8 to 120 µm.

4. (New) A photosensitive element for a field emission display panel according to claim 3, wherein the thickness of the filling layer is 20 to 100 µm.

5. (New) A photosensitive element for a field emission display panel according to claim 4, wherein the thickness of the photosensitive resin composition layer is 10 to 80 μm .

6. (New) A photosensitive element for a field emission display panel according to claim 1, wherein said phosphor is a phosphor capable of forming a phosphor pattern of said field emission display panel.

7. (New) A photosensitive element for a field emission display panel according to claim 1, wherein the photosensitive resin composition layer containing the phosphor has a viscosity at 100°C of 1 to 1 $\times 10^9 \text{ Pa}\cdot\text{sec}$.

8. (New) A photosensitive element for a field emission display panel according to claim 7, wherein said viscosity is 10 to 1 $\times 10^6 \text{ Pa}\cdot\text{sec}$.

9. (New) A photosensitive element for a field emission display panel according to claim 1, wherein said filling layer is made of a resin having thermoplastic properties which deforms by a stress external to the photosensitive element.

10. (New) A photosensitive element for a field emission display panel according to claim 1, wherein the filling layer has a viscosity at 100°C of 1 to 1 $\times 10^9 \text{ Pa}\cdot\text{sec}$.

11. (New) A photosensitive element for a field emission display panel according to claim 10, wherein the viscosity of the filling layer is 10 to 1×10^6 Pa·sec.

12. (New) A photosensitive element for a field emission display panel according to claim 11, wherein the photosensitive resin composition layer containing the phosphor has a viscosity at 100°C of 1 to 1×10^9 Pa·sec.